

## N-Channel MOSFET

### Description

The PSMTOF10R8D uses split gate trench technology to provide excellent  $R_{DS(ON)}$  low gate charge. This device is suitable for power management and high efficiency applications at high switching frequencies applications.

| MOSFET Product Summary |                       |          |
|------------------------|-----------------------|----------|
| $V_{DS}(V)$            | $R_{DS(on)}(m\Omega)$ | $I_D(A)$ |
| 100                    | 6.0@ $V_{GS} = 10V$   | 80       |
|                        | 8.5@ $V_{GS} = 4.5V$  |          |

### Feature

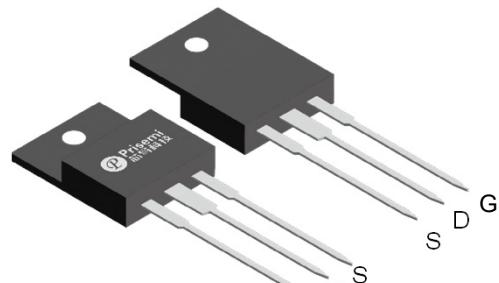
- Low  $R_{DS(ON)}$  - Ensures On-State Losses are Minimized
- Excellent  $Q_{gd} \times R_{DS(ON)}$  Product(FOM)
- Advanced Technology for DC-DC Converts
- Small Form Factor Thermally Efficient Package Enables Higher Density End Products
- 100% UIS (Avalanche) Rated
- Lead-Free Finish ; RoHS Compliant
- Halogen and Antimony Free. "Green" Device

### Applications

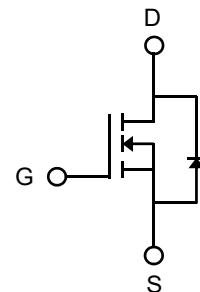
- PWM applications
- Load switch
- Power management
- DC-DC Converters
- Wireless Chargers

### Absolute maximum rating@25°C

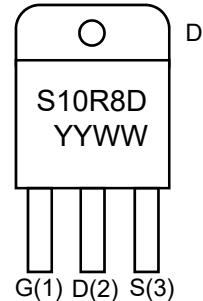
| Rating   | Symbol          | Value    | Units |
|--|-----------------|----------|-------|
| Drain-Source Voltage                                 | $V_{DS}$        | 100      | V     |
| Gate-Source Voltage                                  | $V_{GS}$        | $\pm 20$ | V     |
| Drain Current-Continuous <sup>1)</sup>               | $I_D$           | 80       | A     |
| $T_C=100^\circ C$                                    |                 | 50.8     |       |
| Pulsed Drain Current <sup>2)</sup>                   | $I_{DM}$        | 320      | A     |
| Total Power Dissipation                              | $P_D$           | 97       | W     |
| Avalanche Current <sup>3)</sup>                      | $I_{AS}$        | 67       | A     |
| Avalanche Energy <sup>3)</sup>                       | $E_{AS}$        | 224.5    | mJ    |
| Thermal Resistance , Junction-case <sup>4)</sup>     | $R_{\theta JC}$ | 1.29     | °C/W  |
| Thermal Resistance Junction-to-Ambient <sup>5)</sup> | $R_{\theta JA}$ | 44.5     | °C/W  |
| Junction and Storage Temperature Range               | $T_J, T_{STG}$  | -55~+150 | °C    |



TO-220F



Circuit Diagram



Marking (Top View)

# N-Channel MOSFET

PSMTOF10R8D

## Electrical characteristics per line@25°C (unless otherwise specified)

| Parameter                                     | Symbol       | Conditions   | Min. | Typ. | Max.      | Units   |
|---|--------------|--|------|------|-----------|---------|
| <b>Off Characteristics</b>                    |              |  |      |      |           |         |
| Drain-Source Breakdown Voltage                | $BV_{DSS}$   | $V_{GS} = 0V, I_D = 250\mu A$                              | 100  | -    | -         | V       |
| Zero Gate Voltage Drain Current               | $I_{DSS}$    | $V_{DS} = 100V, V_{GS} = 0V$                               | -    | -    | 1.0       | $\mu A$ |
| Gate-Body Leakage Current                     | $I_{GSS}$    | $V_{GS} = \pm 20V, V_{DS} = 0V$                            | -    | -    | $\pm 100$ | nA      |
| <b>On Characteristics</b>                     |              |  |      |      |           |         |
| Gate Threshold Voltage                        | $V_{GS(th)}$ | $V_{DS} = V_{GS}, I_D = 250\mu A$                          | 1.0  | 2.0  | 3.0       | V       |
| Drain-Source On-State Resistance              | $R_{DS(ON)}$ | $V_{GS} = 10V, I_D = 20A$                                  | -    | 6.0  | 7.5       | mΩ      |
|   |              | $V_{GS} = 4.5V, I_D = 15A$                                 | -    | 8.5  | 10        |         |
| <b>Dynamic Characteristics<sup>6)</sup></b>   |              |  |      |      |           |         |
| Input Capacitance                             | $C_{iss}$    | $V_{DS} = 50V, V_{GS} = 0V, f = 1.0MHz$                    | -    | 2250 | -         | pF      |
| Output Capacitance                            | $C_{oss}$    |  | -    | 620  | -         |         |
| Reverse Transfer Capacitance                  | $C_{rss}$    |  | -    | 13   | -         |         |
| <b>Switching Characteristics<sup>6)</sup></b> |              |  |      |      |           |         |
| Turn-on Delay Time                            | $t_{d(on)}$  | $V_{DS} = 50V, V_{GS} = 10V, I_D = 20A, R_{GEN} = 6\Omega$ | -    | 10.8 | -         | ns      |
| Turn-on Rise Time                             | $t_r$        |  | -    | 11.3 | -         |         |
| Turn-Off Delay Time                           | $t_{d(off)}$ |  | -    | 44.6 | -         |         |
| Turn-Off Fall Time                            | $t_f$        |  | -    | 17.9 | -         |         |
| Total Gate Charge                             | $Q_g$        | $V_{DS} = 50V, V_{GS} = 10V, I_D = 20A$                    | -    | 31   | -         | nC      |
| Gate-Source Charge                            | $Q_{gs}$     |  | -    | 9.0  | -         |         |
| Gate-Drain Charge                             | $Q_{gd}$     |  | -    | 5.2  | -         |         |
| Gate Resistance                               | $R_g$        | $V_{GS}=0V, V_{DS}=0V, f=1MHz$                             | -    | 1.3  | -         | Ω       |
| <b>Drain-Source Diode Characteristics</b>     |              |  |      |      |           |         |
| Diode Forward Voltage                         | $V_{SD}$     | $V_{GS} = 0V, I_S = 50A$                                   | -    | 0.9  | 1.4       | V       |
| Body Diode Reverse Recovery Time              | $t_{rr}$     | $I_F=10A, d_i/d_t=100A/\mu s, V_R=50V$                     | -    | 39   | -         | ns      |
| Body Diode Reverse Recovery Charge            | $Q_{rr}$     |  | -    | 63   | -         | nC      |

Notes:

1. Computed continuous current assumes the condition of  $T_{J\_Max}$  while the actual continuous current depends on the thermal & electro-mechanical application board design.
2. Repetitive Rating: Pulse width limited by maximum junction temperature( $T_{J\_Max}=150^{\circ}C$ ).
3. This single-pulse measurement was taken under the following condition [ $L=100\mu H, V_{GS}=10V, V_{DS}=100V$ ]while it's value is limited by  $T_{J\_Max}=150^{\circ}C$ .
4. Device mounted on infinite heatsink.
5. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper pad layout.
6. Guaranteed by design, not subject to production.

## Typical Characteristics

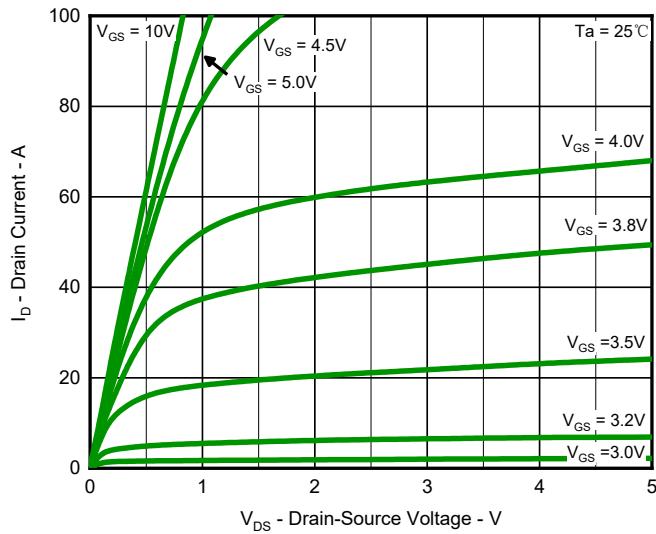


Fig.1 Output Characteristics

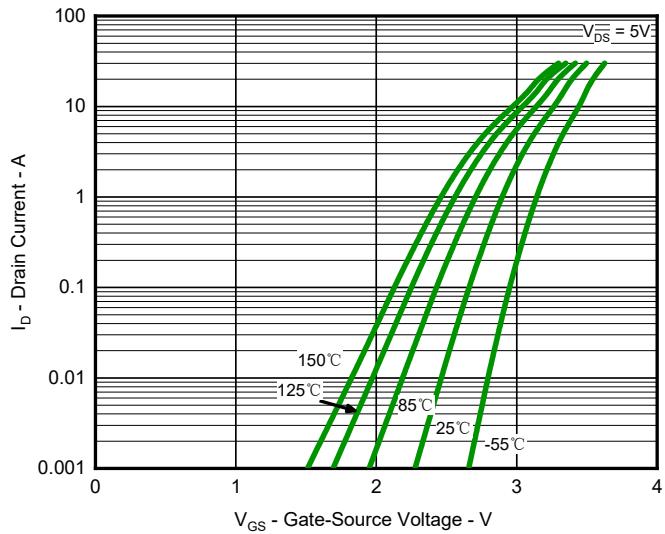


Fig.2 Typical Transfer Characteristic

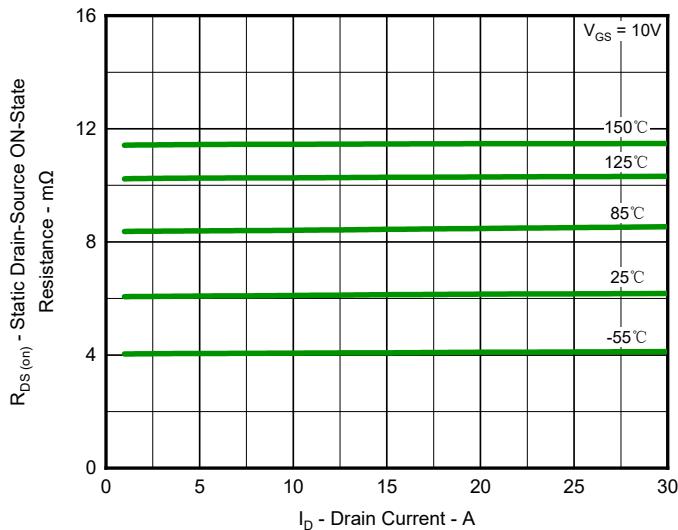


Fig.3 Typical On-Resistance vs. Drain Current and Temperature

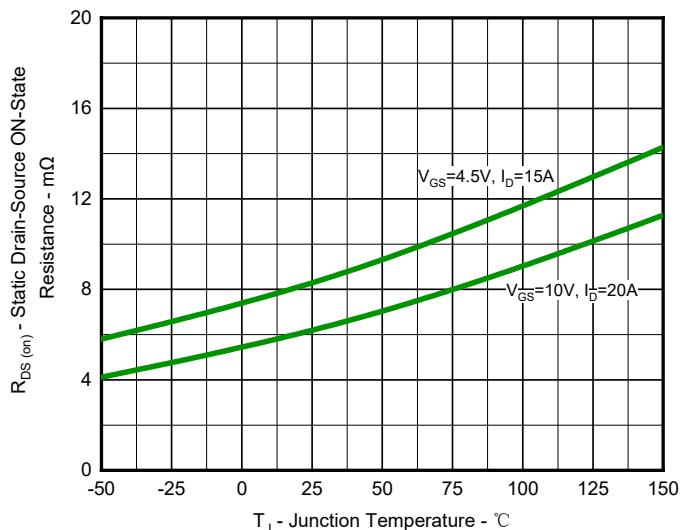


Fig.4 On-Resistance Variation with Temperature

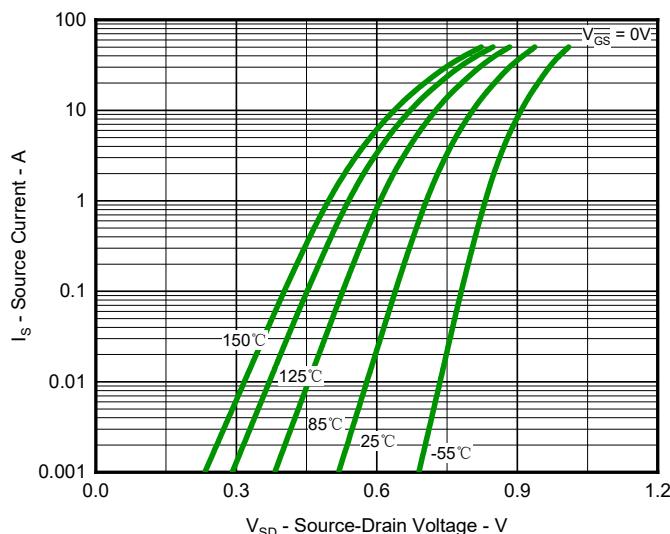


Fig.5 Diode Forward Voltage vs. Current

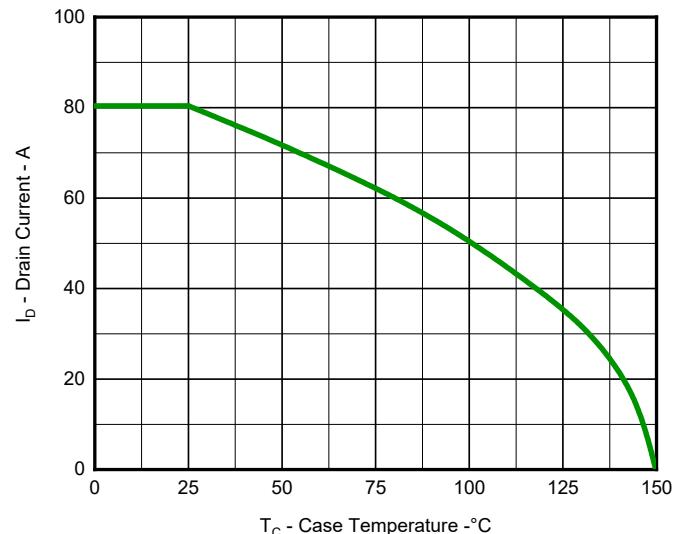


Fig.6 Maximum Drain Current vs. Case Temperature

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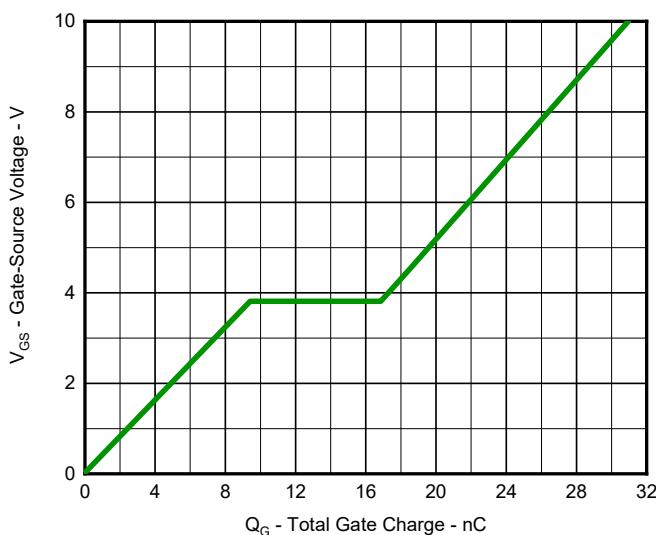


Fig.7 Gate Charge Characteristics

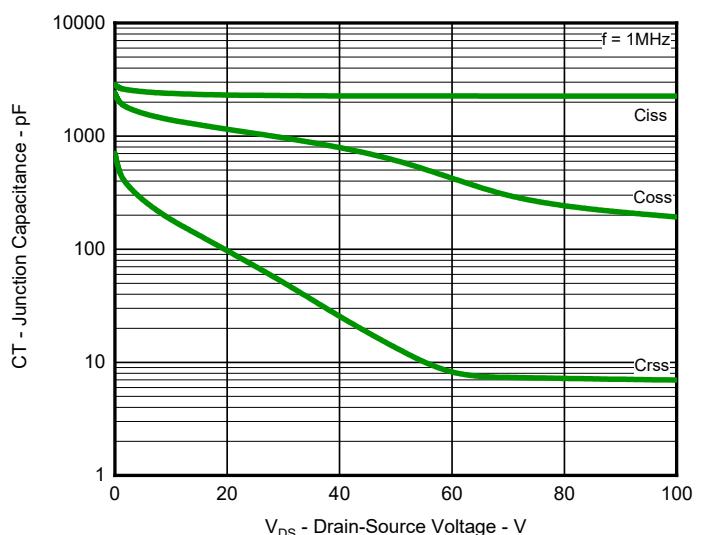


Fig.8 Typical Junction Capacitance

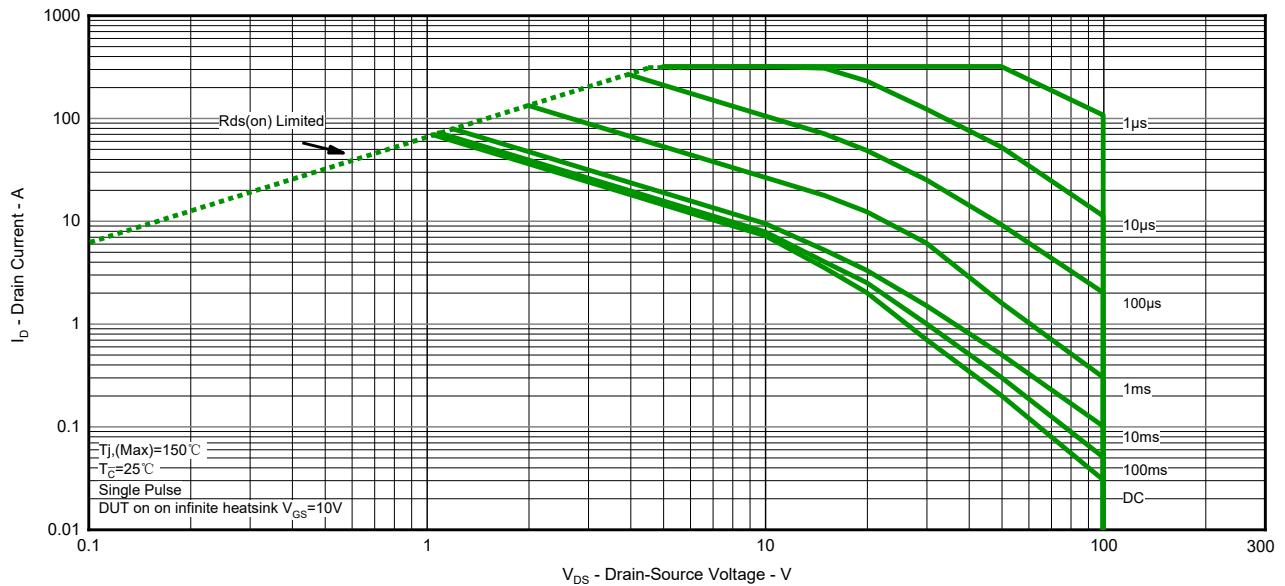


Fig.9 Safe Operation Area

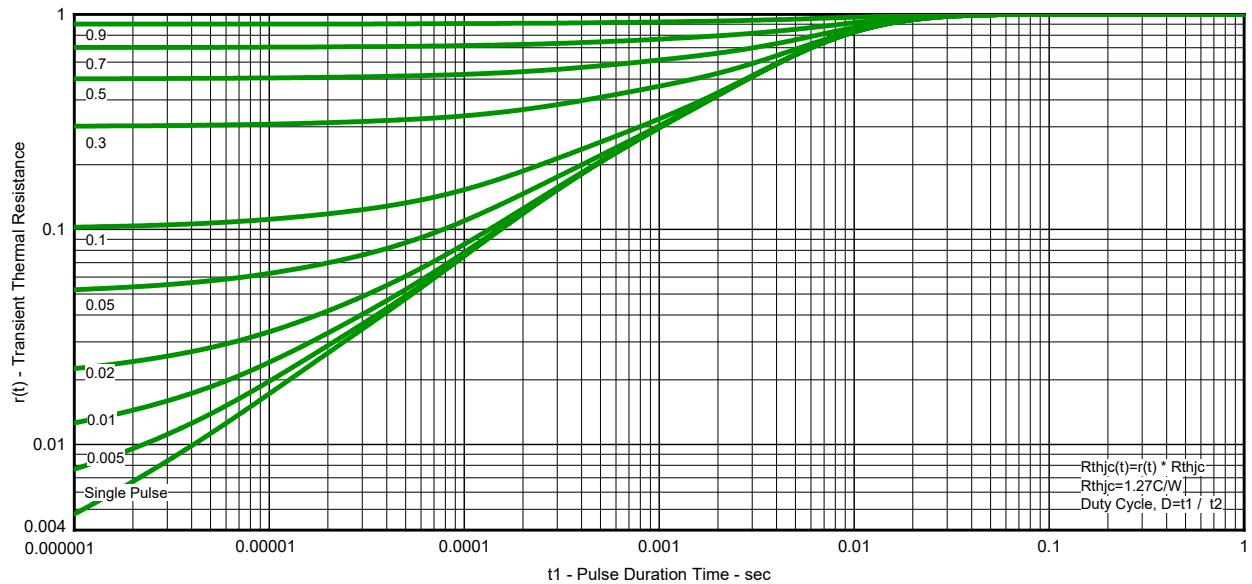
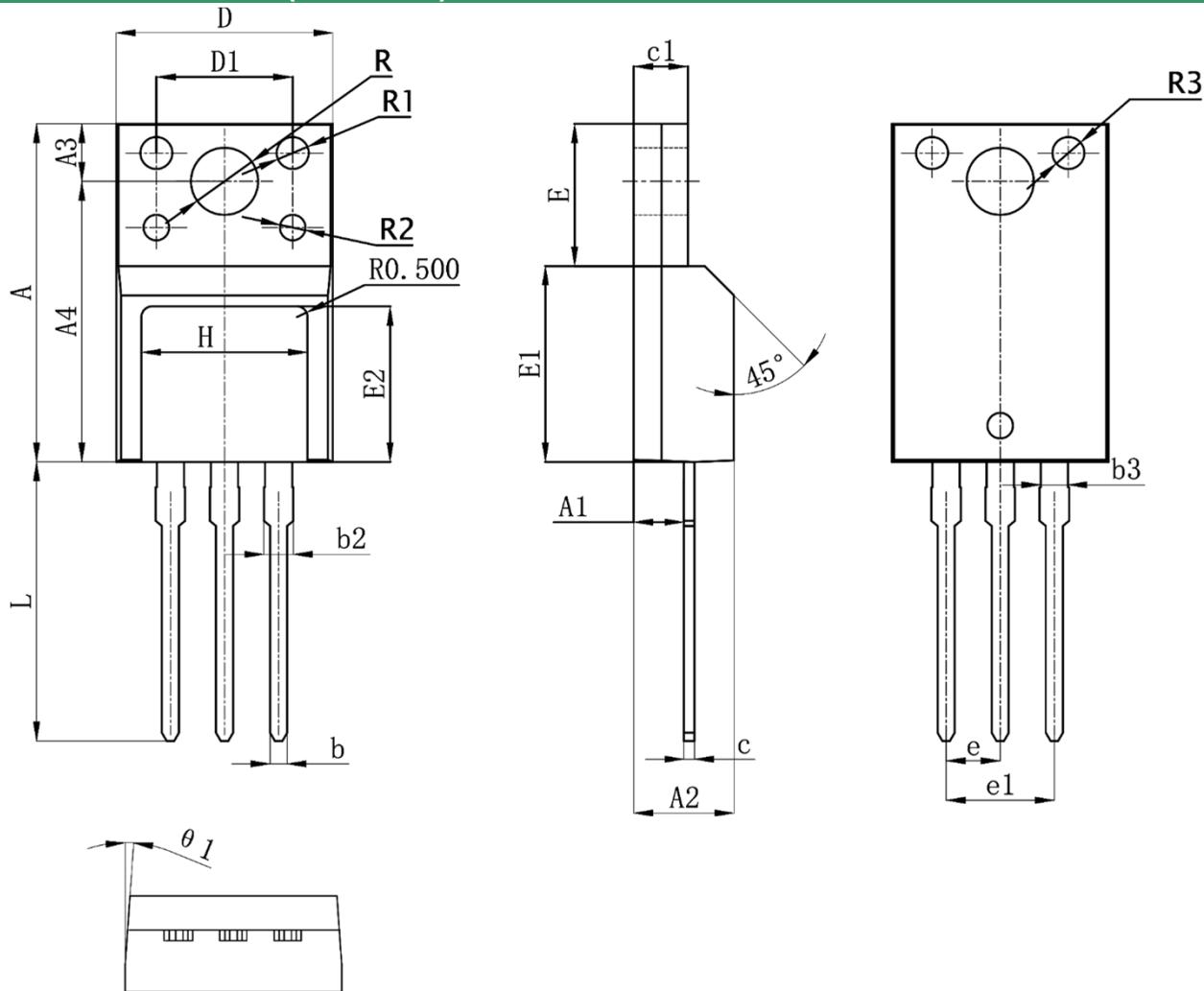


Fig.10 Transient Thermal Resistance

## Product dimension (TO-220F)



| Dim | Millimeters |       | Inches    |       | Dim | Millimeters |       | Inches     |       |
|-----|-------------|-------|-----------|-------|-----|-------------|-------|------------|-------|
|     | Min         | Max   | Min       | Max   |     | Min         | Max   | Min        | Max   |
| A   | 15.67       | 16.07 | 0.617     | 0.633 | E   | 6.48        | 6.88  | 0.255      | 0.271 |
| A1  | 2.15        | 2.55  | 0.085     | 0.100 | E1  | 8.99        | 9.39  | 0.354      | 0.370 |
| A2  | 4.50        | 4.90  | 0.177     | 0.193 | E2  | 7.10        | 7.50  | 0.280      | 0.295 |
| A3  | 3.10        | 3.50  | 0.122     | 0.138 | e   | 2.54 BSC    |       | 0.100 BSC  |       |
| A4  | 12.27       | 12.87 | 0.483     | 0.507 | e1  | 5.08 BSC    |       | 0.200 BSC  |       |
| b   | 0.77        | 0.83  | 0.030     | 0.033 | L   | 13.14       | 13.54 | 0.517      | 0.533 |
| b2  | 1.20        | 1.40  | 0.047     | 0.055 | R   | 3.10        | 3.50  | 0.122      | 0.138 |
| b3  | 1.20 BSC    |       | 0.047 BSC |       | R1  | 1.50 Ref.   |       | 0.059 Ref. |       |
| c   | 0.40        | 0.60  | 0.016     | 0.024 | R2  | 1.20 Ref.   |       | 0.047 Ref. |       |
| c1  | 2.44        | 2.64  | 0.096     | 0.104 | R3  | 1.50 Ref.   |       | 0.059 Ref. |       |
| D   | 9.86        | 10.46 | 0.388     | 0.412 | H   | 7.60        | 8.00  | 0.299      | 0.315 |
| D1  | 6.90        | 7.10  | 0.272     | 0.280 | θ1  | 4°          | 5°    | 4°         | 5°    |

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